

Fema Part Number

GM800480A-50-TTX2-HTGG	
	5.0" Full Color TFT
	800X480 Resolution
	High bright 600 nits (typical)
	Integrated capacitive touchpanel
	Goodix GT911 Controller on flex

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Please visit our website www.femaelectronics.com or email us at tft@femacorp.com

1. GENERAL INFORMATION

No.	Item	Contents	Unit
1	LCD size	5.0 inch (Diagonal)	/
2	LCD type	TN/Normally white/Transmissive(Anti-glare)	/
3	Viewing direction(eye)	12 O'clock	/
4	Gray scale inversion direction	6 O'clock	/
5	Resolution(H*V)	800 *480 Pixels	/
6	Module size (L*W*H)	128.80*88.30*4.45	mm
7	Active area (L*W)	108.00*64.80	mm
8	Pixel pitch (L*W)	0.135*0.135	mm
9	Interface type	RGB interface	/
10	Module power consumption	TBD	W
11	Back light type	LED	/
12	Driver IC	ILI6122+ILI5960 OR COMPATIBLE	/
13	Weight	TBD	g

2. ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Min.	Max.	Unit
Power supply input voltage(TFT Module)	VDD	-0.3	5.0	V
Backlight current (normal temp.)	ILED	-	50	mA
Operation temperature	Top	-20	+70	°C
Storage temperature	Tst	-30	+80	°C
Humidity	RH	-	90%(Max60 °C)	RH

3. ELECTRICAL CHARACTERISTICS

DC CHARACTERISTICS(at Ta=25°C)

Item	Symbol	Min.	Typ.	Max.	Unit	Note
Power supply input voltage(TFT Module)	VDD	3.0	3.3	3.6	V	
I/O logic voltage	VDDIO	-	-	-	V	
Input voltage 'H' level	VIH	0.7VDDIO	-	VDDIO	V	
Input voltage 'L' level	VIL	VSS	-	0.3VDDIO	V	
Power supply current	IVDD	-	TBD	-	mA	
TFT gate on voltage	VGH	-	-	-	V	Note1
TFT gate off voltage	VGL	-	-	-	V	Note1
Analog power supply voltage	AVDD	-	-	-	V	Note1
Differential input common mode voltage	Vcom	-	-	-	V	Note1

Note1 : The value is just the reference value. The customer can optimize the setting value by the different D-IC
Vcom must be adjusted to optimize display quality, as Crosstalk and Contrast Ratio etc..

4. BACKLIGHT CHARACTERISTICS

(at Ta=25°C,RH=60%)

Item	Symbol	Min.	Typ.	Max.	Unit	Note
LED forward voltage	VF	22.4	25.6	27.2	V	IF=20*2mA
LED forward current	IF	-	40	-	mA	
LED power consumption	PLED	-	1.024	-	W	Note1
Number of LED	-		16		PCS	
Connection mode	-	8 in series 2 in parallel			/	
LED life-time	-	20000	-	-	Hrs	Note2

Note1 : Calculator value for reference : IF*VF = PLED

Note2 : The LED life-time define as the estimated time to 50% degradation of initial brightness at Ta=25°C and IF =40mA. The LED lifetime could be decreased if operating IF is larger than 40mA.

5. TOUCH PANEL CHARACTERISTICS

(at Ta=25°C)

FPC Design	Item	Description	Note
[√] COF	IC solution on TP Model	GT911	
	Touch Count Max	5 point	
	Display Resolution*	800*480	
	Interface Type *	I2C	
	I2C Slave Address*	0x5D	
	Origin of Coordinate*	top left corner	
[] COB	IC solution on Broad*		
	Driving Channels		
	Sensing Channels		

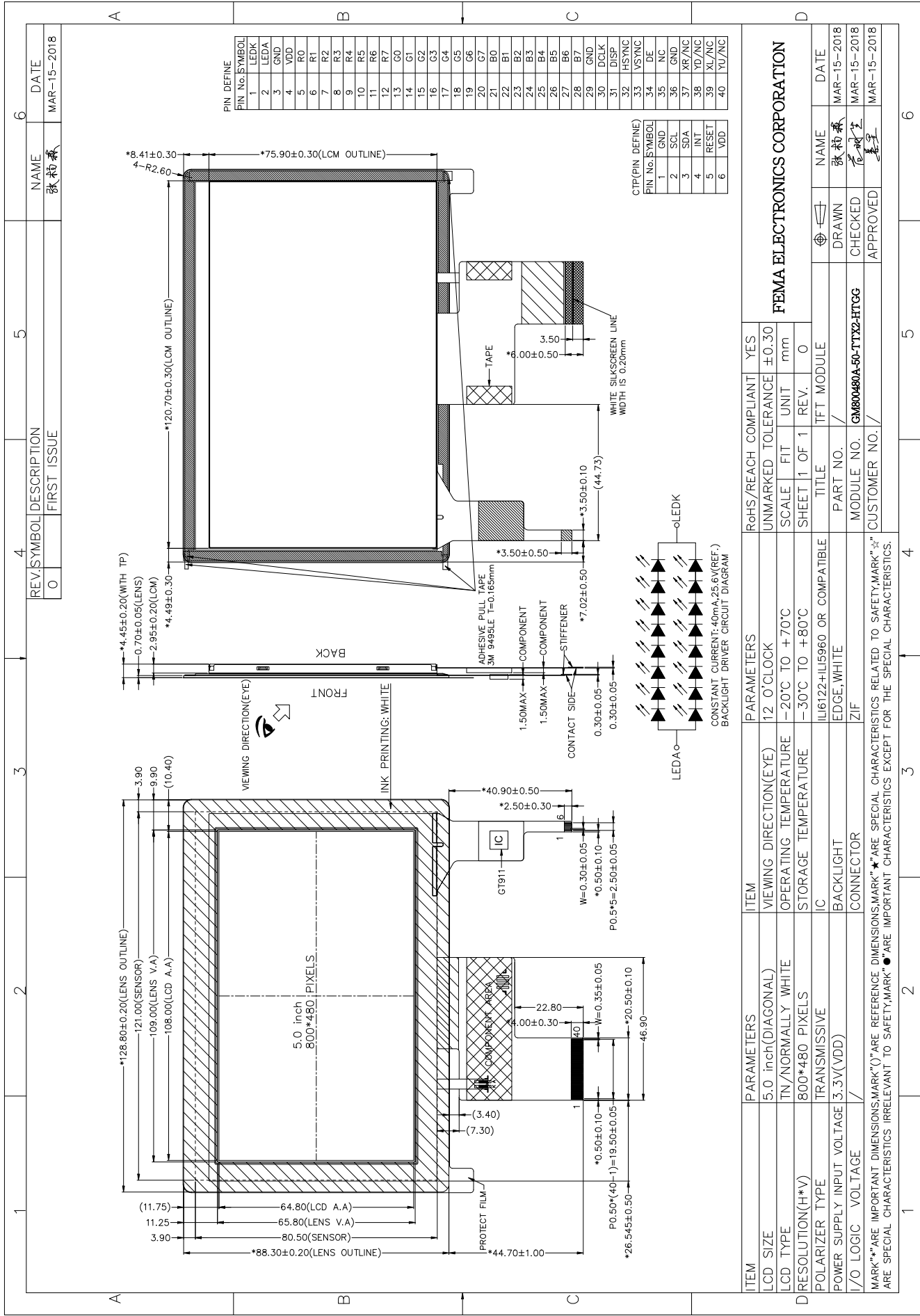
Parameter	Min.	Typ.	Max.	Unit
Interface Signal Voltage*	1.8	3.3	3.6	V
Power Voltage*	2.6	3.3	3.6	V
Power ripple*	-	-	50	mV

Note1 : The detail refer to the Specification for IC.

Note2 : “*” means that the item is optional according to the product requirement.

Note3 : If you need more information of CTP, please refer to our Spec of CTP.

6. EXTERNAL DIMENSIONS



7. ELECTRO-OPTICAL CHARACTERISTICS

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	Remark	Note
Response time	Tr+ Tf	-	-	25	50	ms	FIG.1	Note 4
Contrast ratio	Cr		400	500	-	-	FIG.2	Note 1
Surface luminance	Lv	$\theta=0^\circ$	600	750	-	cd/m ²	FIG.2	Note 2
Luminance uniformity	Yu	$\theta=0^\circ$	75	80	-	%	FIG.2	Note 3
NTSC	-	$\theta=0^\circ$	-	50	-	%	FIG.2	Note 5
Viewing angle	θ	$\phi=90^\circ$	60	70	-	deg	FIG.3	Note 6
		$\phi=270^\circ$	40	50	-	deg	FIG.3	
		$\phi=0^\circ$	60	70	-	deg	FIG.3	
		$\phi=180^\circ$	60	70	-	deg	FIG.3	
CIE (x,y) chromaticity	Red x	$\theta=0^\circ$ $\phi=0^\circ$ Ta=25°C	Typ -0.04	TBD	Typ +0.04	-	FIG.2 CIE1931	Note 5
	Red y			TBD		-		
	Green x			TBD		-		
	Green y			TBD		-		
	Blue x			TBD		-		
	Blue y			TBD		-		
	White x			TBD		-		
	White y			TBD		-		

Note1.Definition of contrast ratio

Contrast ratio(Cr) is defined mathematically by the following formula.

For more information see FIG.2.

Contrast ratio= $\frac{\text{Luminance measured when LCD on the "White" state}}{\text{Luminance measured when LCD on the "Black" state}}$

Measured at the center area of the LCD

Note2.Definition of surface luminance

Surface luminance is the luminance with all pixels displaying white.

For more information see FIG.2.

L_v = Average Surface Luminance with all white pixels(P1,P2,P3,,Pn)

Note3.Definition of luminance uniformity

The luminance uniformity in surface luminance is determined by measuring luminance at each test position 1 through n, and then dividing the maximum luminance of n points luminance by minimum luminance of n points luminance.For more information see FIG.2.

$Y_u = \frac{\text{Minimum surface luminance with all white pixels (P1,P2,P3,.....,Pn)}}{\text{Maximum surface luminance with all white pixels (P1,P2,P3,.....,Pn)}}$

Note4. Definition of response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state.Rise time (T_{ON}) is the time between photo detector output intensity changed from 90% to 10%.

And fall time (T_{OFF}) is the time between photo detector output intensity changed from 10% to 90%.

For additional information see FIG1.

Note5. Definition of color chromaticity (CIE1931)

CIE (x,y) chromaticity,The x,y value is determined by screen active area center position P5.For more information see FIG.2.

Note6. Definition of viewing angle

Viewing angle is the angle at which the contrast ratio is greater than 10. angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface.

For more information see FIG.3.

For viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope or DMS series Instruments or compatible. For contrast ratio, Surface Luminance, Luminance uniformity and CIE,the testing data is base on TOPCON's BM-5or BM-7 photo detector or compatible.

FIG.1. The definition of response Time

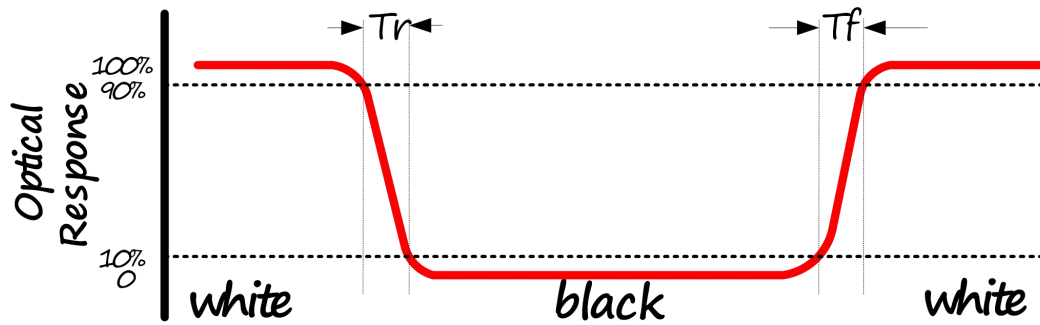


FIG.2. Measuring method for contrast ratio, surface luminance, luminance uniformity, CIE (x,y) chromaticity

Size : $S \leq 5"$ (see Figure a)

A : 5 mm B : 5 mm

H,V : Active area

Light spot size $\varnothing = 5\text{mm}$ (BM-5) or $\varnothing = 7.7\text{mm}$ (BM-7) 50cm distance or compatible distance from the LCD surface to detector lens.

test spot position : see Figure a.

measurement instrument : TOPCON's luminance meter BM-5 or BM-7 or compatible (see Figure c).

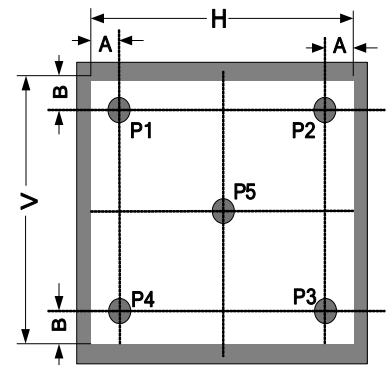


Figure a

Size : $5" < S \leq 12.3"$ (see Figure b)

H,V : Active area

Light spot size $\varnothing = 5\text{mm}$ (BM-5) or $\varnothing = 7.7\text{mm}$ (BM-7) 50cm distance or compatible distance from the LCD surface to detector lens.

test spot position : see Figure b.

measurement instrument : TOPCON's luminance meter BM-5 or BM-7 or compatible (see Figure c).

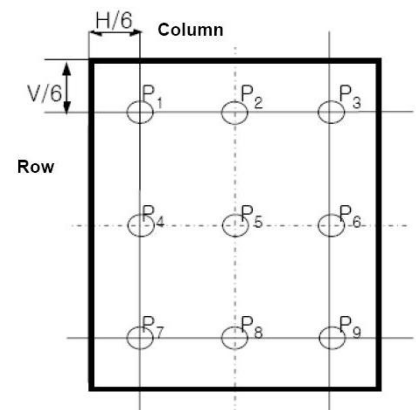


Figure b

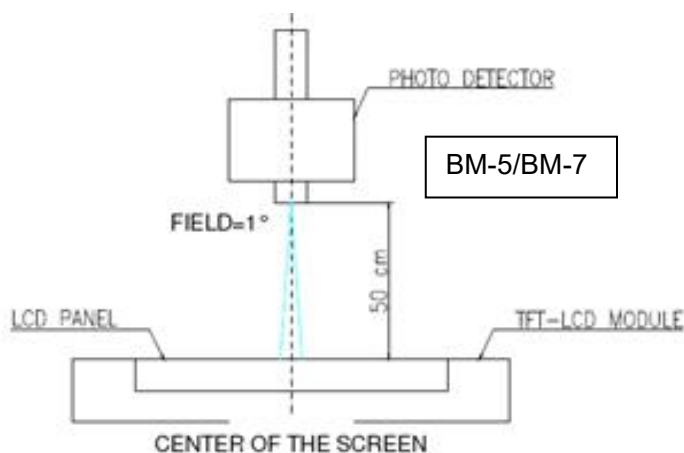
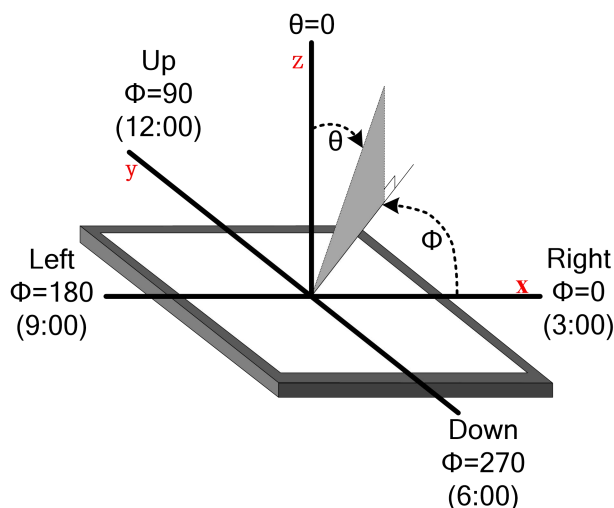


Figure c

FIG.3. The definition of viewing angle



8. INTERFACE DESCRIPTION

TFT Module Interface description

Interface No.	Name	I/O or connect to	Description
1	LEDK	P	Power for LED backlight(Cathode)
2	LEDA	P	Power for LED backlight(Anode)
3	GND	P	Ground
4	VDD	P	Power for LCD
5-12	Red(0-7)	I	Red data
13-20	Green(0-7)	I	Green data
21-28	Blue(0-7)	I	Blue data
29	GND	I	Ground
30	DCLK	I	Dot clock
31	DISP	I	Display on/off
32	HSYNC	I	Horizontal sync input.
33	VSYNC	I	Vertical sync input
34	DE	I	Data enable
35	NC	/	/
36	GND	P	Power ground
37	XR/NC	/	/
38	YD/NC	/	/
39	XL/NC	/	/
40	YU/NC	/	/

CTP interface description

Interface No.	Name	I/O or connect to	Description
1	GND	P	Ground
2	SCL	I	Serial interface clock
3	SDA	I/O	Serial interface date
4	INT	O	State change interrupt
5	RESET	I	Reset low
6	VDD	P	Power Supply of CTP

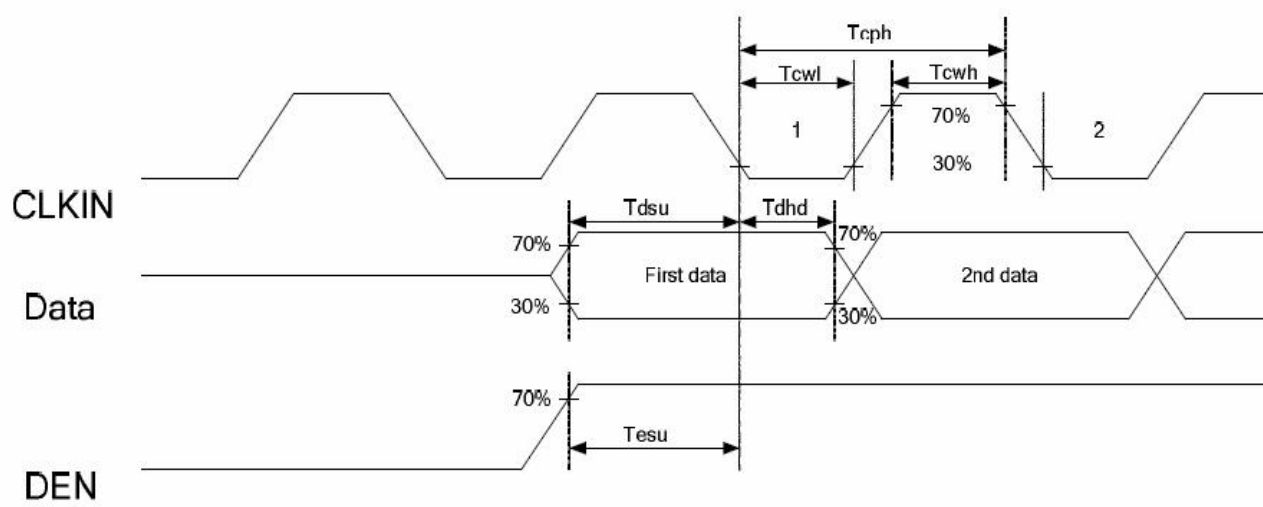
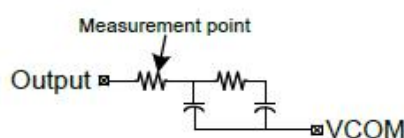
9. AC CHARACTERISTICS

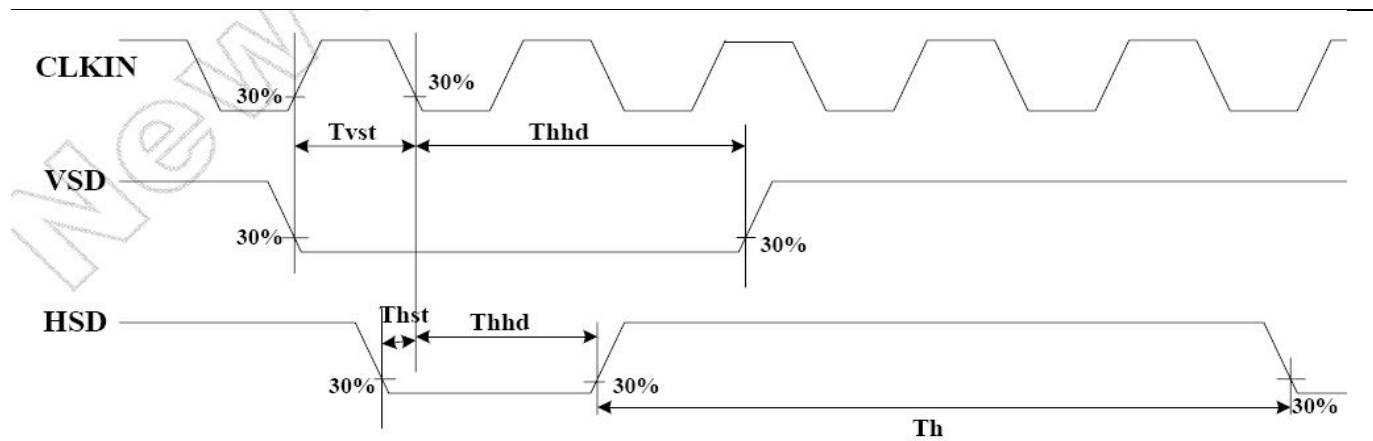
Parameter	Symbol	Spec			Unit	Conditions
		Min.	Typ.	Max.		
VDD Power ON slew rate	t_{POR}	--	--	20	ms	0V ~ 0.9VDD
RSTB pulse width	t_{RST}	10	--	--	us	CLKIN=50MHz
CLKIN cycle time	t_{CPH}	20	--	--	ns	
CLKIN pulse duty	t_{CWH}	40	50	60	%	
VSD setup time	t_{VST}	8	--	--	ns	
VSD hold time	t_{VHD}	8	--	--	ns	
HSD setup time	t_{HST}	8	--	--	ns	
HSD hold time	t_{HHD}	8	--	--	ns	
Data setup time	t_{DST}	8	--	--	ns	D0[7:0], D1[7:0], D2[7:0] to CLKIN
Data hold time	t_{DHD}	8	--	--	ns	D0[7:0], D1[7:0], D2[7:0] to CLKIN
DE setup time	t_{EST}	8	--	--	ns	
DE hold time	t_{EHD}	8	--	--	ns	
Output stable time	t_{SST}	--	--	6	us	10% to 90% target voltage. CL=120pF, R=10KΩ
CLKIN frequency	f_{CLK}	--	40	50	MHz	VDD=3.0 ~ 3.6V
CLKIN cycle time	t_{CLK}	20	25	--	ns	
CLKIN pulse duty	t_{CWH}	40	50	60	%	T_{CLK}
Time from HSD to Source output	t_{HSO}	--	20	--	CLKIN	
Time from HSD to LD	t_{HLD}	--	20	--	CLKIN	Note (2)
Time from HSD to STV	t_{HSTV}	--	2	--	CLKIN	
Time from HSD to CKV	t_{HCKV}	--	20	--	CLKIN	
Time from HSD to OEV	t_{HOEV}	--	4	--	CLKIN	
LD pulse width	t_{WLD}	--	10	--	CLKIN	Note (2)
CKV pulse width	t_{WCKV}	--	66	--	CLKIN	
OEV pulse width	t_{WOEV}	--	74	--	CLKIN	

Note: (1) VDD=3.0 ~ 3.6V, VDDA=6.5~13.5V, DGND=AGND=0V, $T_a=-20\sim+85^{\circ}\text{C}$

(2) The contents of the data register are transferred to the latch circuit at the rising edge of LD. Then the gray scale voltage is output from the device at the falling edge of LD.

(3) Output loading condition :





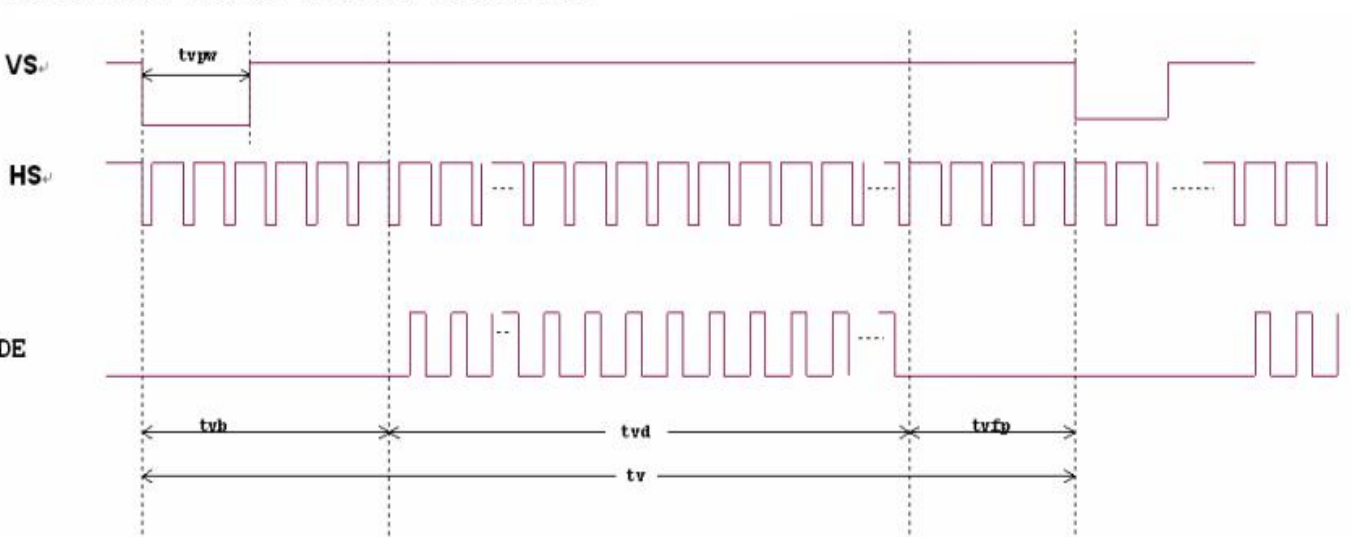
Horizontal Input Timing						
Parameter		Symbol	Value			Unit
			Min.	Typ.	Max.	
Horizontal display area		t_{HD}	--	800	--	CLKIN
CLKIN frequency		f_{CLK}	--	33.3	50	MHz
1 Horizontal line period		t_H	862	1056	1200	CLKIN
HSD pulse width	Min.	t_{HPW}	--	1	--	CLKIN
	Typ.		--	--	CLKIN	
	Max.		--	40	--	CLKIN
HSD back porch	SYNC	t_{HBP}	46	46	46	CLKIN
HSD front porch	SYNC	t_{HFP}	16	210	354	CLKIN

Vertical Input Timing					
Parameter	Symbol	Value			Unit
		Min.	Typ.	Max.	
Vertical display area	t_{VD}	--	480	--	HSD
VSD period time	t_V	510	525	650	HSD
VSD pulse width	t_{VPW}	1	--	20	HSD
VSD back porch	t_{VBP}	23	23	23	HSD
VSD front porch	t_{VFP}	7	22	147	HSD

Horizontal input timing diagram.



Vertical input timing diagram.



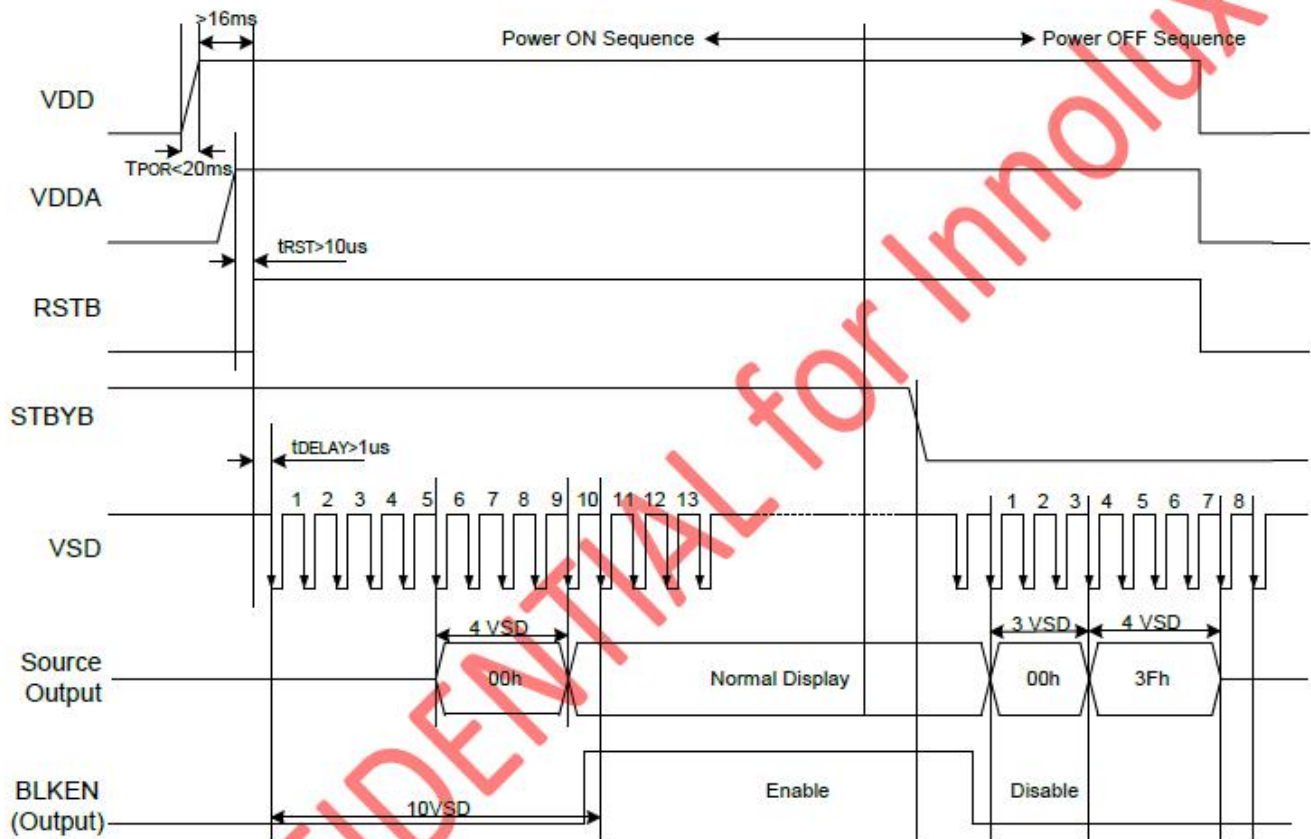
10. POWER SEQUENCE

To prevent the device damage from latch up, the power ON/OFF sequence shown below must be followed.

Power ON: VDD, DGND → VDDA, AGND → V1 to V14

Power OFF: V1 to V14 → VDDA, AGND → VDD, DGND

In order to prevent ILI6122 from power ON reset fail, the rising time (t_{POR}) of the digital power supply VDD should be maintained within given specifications. The power ON/OFF timing sequence is illustrated as below:



Note: For prevent anormal operation, t_{RST} must be longer than 10us during Power ON sequence.

11. RELIABILITY TEST CONDITIONS

No.	Test item	Test condition		Inspection after test
11.1	High temperature storage test	+80°C/240 hours		Inspection after 2~4hours storage at room temperature, the sample shall be free from defects : 1.Current changing value before test and after test is 50% larger; 2. Function defect : Non-display,abnormal-d isplay,missing lines, Short lines,ITO corrosion; 3.Visual defect : Air bubble in the LCD,Seal leak,Glass crack.
11.2	Low temperature storage test	-30°C/240 hours		
11.3	High temperature operating test	+70°C/120 hours		
11.4	Low temperature operating test	-20°C/120 hours		
11.5	Temperature cycle storage test	-30°C ~ 25°C ~ +80°C/10cycles (30min.) (10min.) (30min.)		
11.6	High temperature high humidity test	+50°C*90% RH/120 hours		
11.7	Vibration test	Frequency : 250 r/min Amplitude : 1 inch Time: 45min		
11.8	Drop test	Drop direction: 1 corner/3 edges/6 sides 10 time		
		Packing weight(kg)	Drop height(cm)	
		<11	80±1.6	
		11≦G<21	60±1.2	
		21≦G<31	50±1.0	
		31≦G<40	40±0.8	
11.9	ESD test	Air discharge: ±8KV, 10time Contact discharge: ±4KV, 10time		
Remark : 1.The test samples should be applied to only one test item. 2.Sample size for each test item is 3~5pcs. 3.For High temperature high humidity test, Pure water(Resistance>10MΩ) should be used. 4.In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part. 5.B/L evaluation should be excepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence B/L has. 6.Failure judgment criterion: Basic specification, Electrical characteristic, Mechanical characteristic, Optical characteristic.				

12. INSPECTION CRITERION

12.1 Objective

The CTP test criterion are set to formalize CTP quality standards for FEMA with reference to those of the customer for inspection, release and acceptance of finished CTP products in order to guarantee the quality of CTP products required by the customer.

12.2 Scope

This specification is applicable to capacitive touch panel manufactured by FEMA.

12.3 Equipment for Inspection

lamp-box、ionizing fan、10X microscopes、film card、alcohol/oil ether/acetone、finger cots、vernier caliper、anti-static wrist straps、microcalliper、feeler、pencil hardness tester、spectrophotometer、drop ball test,etc.

12.4 Sampling Plan and Reference Standards

12.4.1.1 Sampling plan:

Refer to National Standard GB/T 2828.1---2012/ISO2859-1:1999, level II of normal levels:

Major defect: AQL 0.4

Minor defect: AQL 1.0

12.5 Inspection Conditions and Inspection Reference

12.5.1 Inspection environment: temperature: $23\pm3^{\circ}\text{C}$; humidity: 45~75%RH; cleanness: 10000 grade;

12.5.2 Inspection distance: $30\text{cm}\pm5\text{cm}$;

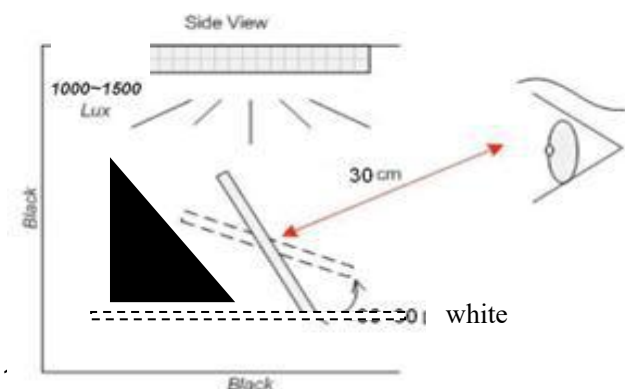
12.5.3 Inspection angle: vertical rotate angle: $\pm30^{\circ}$, up->down;horizontal rotate angle: $\pm30^{\circ}$,left->right

12.5.4 Inspection luminance : fluorescent (finished product) inspection luminance is 800~1200Lux;

12.5.5 Background color: black/white;

12.5.6 Inspection time : 10~15s/ pcs

Black Booth or Black Background



12.5.7.1 A area: front side visible area - BM(Black Mask), the area encircled by blue lines.

12.5.7.2 B area: four broadside(inspect from broadside) area & FPC area,encircled by green lines.



12.5.8 Defect type:

12.5.8.1 A area defect type:

Line defect (scratch、soft flocks、fibre)、dot defect (white dot、black dot、same color dot、different color dot、dust、bubble)、surface stain、pin-hole、light leak、scratch.

12.5.8.2 B area defect type:

Broken、crack/chipping、FPC defect

12.5.9 Undefined items or other special items, refer to mutual agreement and limited sample.If criterion does not match product specifications/ technical requirement, both should be subject to special inspection criterion agreed by customer.

12.6 Defects and Acceptance Standards

12.6.1 Electrical properties test

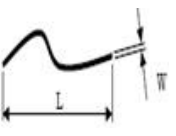
Check in FEMA tester.The program will release result automatically. There are “OK”、“PASS”、“NG”and the final judgment must be“OK”“PASS”,and we need to pass the draw line test.

Refer to 《**serie IC test program》

No.	Defects	Descriptions	Accepted standard	MAJ.	MIN.
12.6.1.1	Short	Measured data has much difference compared with normal;line is not stable	Reject	√	
12.6.1.2	Open	Measured data has no change.Line is open	Reject	√	
12.6.1.3	No reaction	No reaction and there is no line in screen	Reject	√	
12.6.1.4	Mis-display/ abnormal display	Screen has display but line is open or bent	Reject	√	
12.6.1.5	Button no reaction	Press the button but no reaction	Reject	√	
12.6.1.6	Button not correct	Press the button .Reaction is not stable	Reject	√	


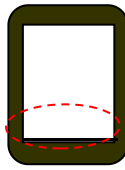
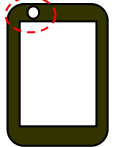
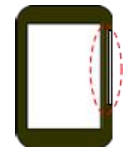

12.6.2 Appearance inspection

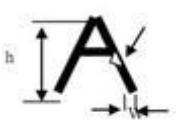

12.6.2.1 Dot/line defect

Defect	≤5”	5~10”	10~15”	>15”	Accepted standard	MAJ.	MIN.
S/C , line defect W:width L:length 	Tactile S/C->NG	Tactile S/C->NG	Tactile S/C->NG	Tactile S/C->NG	Reject		√
	W≤0.03mm, ->OK; Density is high ->NG	W≤0.05mm, ->OK; Density is high ->NG	W≤0.05mm, ->OK; Density is high ->NG	W≤0.05mm, ->OK; Density is high ->NG	Accept		√
	0.03mm< W≤0.10mm, L≤5mm quantity≤4 distance> 10mm	0.05mm< W≤0.1mm, L≤8mm quantity≤6 distance> 10mm	0.05mm< W≤0.1mm, L≤10mm quantity≤6 distance> 10mm	0.05mm< W≤0.1mm, L≤20mm quantity≤8 distance> 10mm	Accept		√
	W>0.10mm L>5mm	W>0.1mm L>8mm	W>0.1mm L>10mm	W>0.1mm L>20mm	Reject		√

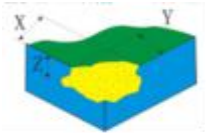
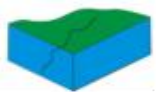
Dot defect D:Diameter 	W≤0.10mm, ->OK;	W≤0.15mm, ->OK;	W≤0.15mm, ->OK;	W≤0.15mm, ->OK;	Accept		√
	0.10mm<D≤ 0.25mm quantity≤4 distance> 10mm	0.15mm<D≤ 0.30mm quantity≤6 distance> 10mm	0.15mm<D≤ 0.40mm quantity≤6 distance> 10mm	0.20mm<D ≤ 0.50mm quantity≤5 distance> 10mm	Accept		√
	D>0.25mm	D>0.30mm	D>0.40mm	D> 0.50mm	Reject		√

12.6.2.2 LENS defect


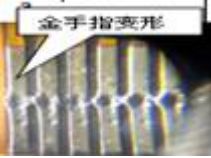

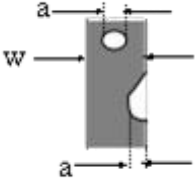
Defect	Description	Accepted standard	MAJ.	MIN.
Printing zigzag 	zigzag width which is almost the same with VA area W≤0.15mm	Accept		√
	zigzag width which is almost the same with VA area W>0.15mm	Reject		√
Wire mark 	≤0.15mm	Accept		√
	>0.15mm	Reject		√
Ink pinhole 	Invisible with reflector light	Accept		√
Ink film defect	Ink film:s/c、 soft flocks、 fibre Ink film stain/color shift:refer to limited sample Ink film foreign material/scratch: refer to 6.2.1 visible area judgment	Accept		√
Ink light leak 	Broadside light leak width≤0.15mm Each side light leak quantity≤1	Accept		√
Ink color shift	Refer to limited sample			√
font、glass silver line (ink area) width≥0.2mm 	D≤0.20mm; N≤2 ↑	Accept		√
	D>0.20mm	Reject		√
	Refer to limited sample, if it's out of spec	Reject		√

word/color error	Word or color or position is different from drawing and sample.	Reject	√	
word missing width≤0.2mm 	height, $a \leq 1/4h$, width $\leq 1/2w$	Accept		√
Font thickness different and color nonuniform 	Refer to limited sample, if it's out of spec	Reject		√
IR/video/ Receive hole /Button hole	Irregular hole , offside, refer to drawing	Accept		√
	Foreign material/scratch exist in hole, refer to 6.2.1	Reject		√
LENS broadside foreign material	Width $\leq 0.15\text{mm}$	Accept		√
Ink spill	LENS broadside or receive hole or button hole have ink spill defect, refer to limited sample.	Accept		√

12.6.2.3 Breakage

Defect	≤5"	5~10"	10~15"	>15"	Accepted standard	MAJ.	MIN.
LENS breakage 	$X \leq 0.3\text{mm}$, $Y \leq 0.3\text{mm}$, one side ≤ 1	$X \leq 0.3\text{mm}$, $Y \leq 0.4\text{mm}$, one side ≤ 1	$X \leq 0.4\text{mm}$, $Y \leq 0.4\text{mm}$, one side ≤ 1	$X \leq 0.5\text{mm}$, $Y \leq 0.5\text{mm}$, one side ≤ 1	Accept		√
	$X > 0.3\text{mm}$, $Y > 0.3\text{mm}$	$X > 0.3\text{mm}$, $Y > 0.4\text{mm}$	$X > 0.4\text{mm}$, $Y > 0.4\text{mm}$	$X > 0.5\text{mm}$, $Y > 0.5\text{mm}$	Reject		√
Sensor breakage	Not affect ITO line, not lengthen, function test is OK And be non-visual after attaching Lens				Accept		√
	affect ITO line and be visual				Reject		√
Glass crack 	Crack lengthen to outside				Accept		√
	Crack lengthen to inside				Reject		√

12.6.2.4 FPC defect

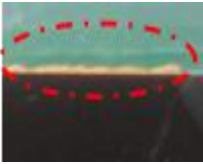
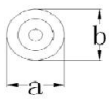
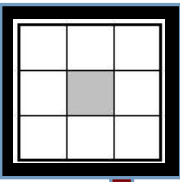
Defect	Description	Accepted standard	MAJ.	MIN.
FPC folding 	FPC is folding and can not restore-> Reject FPC is folding and can restore->compare with limited sample	Reject		√
FPC cover layer defect	FPC cover layer peeling off	Reject		√
FPC color shift and bubble	PI layer have color shift or bubbled due to high welding temperature or long welding time.	Reject		√
Golden finger defect 	peeling off、bonding deformed、glue remained、oxidized, stained	Reject		√
Joggle defect 	bent, broken, peeling off	Reject		√
FPC defect 	(golden finger) dented, pin hole $a \leq w/3$	Accept		√
	open/scratch/cracked	Reject		√
	oxidized, stained	Reject		√
FPC loophole	Soft loophole $\leq 2.0\text{mm}$, hard (PCB、PC、steel cover layer) loophole $\leq 1.0\text{mm}$	Accept		√

12.6.2.5 Attaching defect (protective film/adhesive tape/foam/PC...)

Defect	Description	Accepted standard	MAJ.	MIN.
High temperature glue paper	1. Glue paper attached in FPC doesn't cover component or FPC cover layer. 2. Glue paper attached in golden finger doesn't cover golden finger or peel off	Reject		√
Protective film	Clean、attaching flat、no shifting or bubble	Accept		√
	Protective film attaching bubble in VA: $D \leq 2.0\text{mm}$ $N \leq 5$ distance $\leq 20\text{mm}$	Accept		√
	Protective film attaching bubble in VA: $D > 2.0\text{mm}$ $N > 5$ distance $> 20\text{mm}$	Reject		√

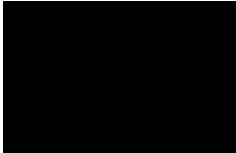
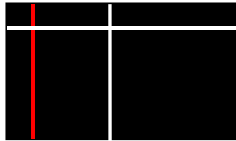
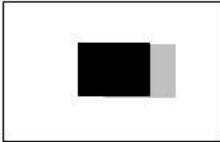

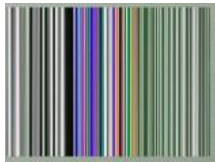
Tape	Attach position refer to the drawing	Accept		√
Foam	Gap spec:0.5+/-0.5mm, foam must be smaller than sensor edge side and can not enter into VA.	Accept		√
PC board/ adhesive tape	Tape must be smaller than LENS edge side and can not be folding ,dent or shifting.	Accept		√
Anti-explosion fim/Anti-glare film/blue film	Impression print refer to the limited sample	Accept		√
	Attach position refer to the drawing	Accept		√

12.6.2.6 Others

Defect	Description	Accepted standard	MAJ.	MIN.
Glue flow 	Insulation oil flow in VA area	Reject		√
	ACF/insulation oil flow in VA area	Reject		√
	Sensor edge side glue flow	Accept		√
IC/FPC gap glue	FPC gap glue:cover FPC connect point totally IC glue: cover IC line connect totally	Accept		√
	Glue height : follow the technology spec	Accept		√
Newton circles (rainbow) 	Circles quantity> 2	Reject		√
Layering	LENS/Sensor layering	Reject	√	
Surface	Stain defect which can be removed by cleaning solvent and cloth Defect quantity≤10% Lot total quantity->Accept Remark: defect product which is sorted out by AQL is not included in the 10% part.Unmovable stain refer to 6.2.1 specification.	Reject		√
Isolation point  VA diagram	Gray area In 8X8mm area, all isolation points are missing	Reject		√
	White area In 15X15mm area,all isolation points are missing	Reject		√
	5mm within VA (black area) , isolation points missing ->Ignored	Accept		√
	Isolation points are overlaid	Accept		√

12.6.3 TFT defects and Inspection Criterion

12.6.3.1 Function items(Defect category MA)

Defects	Inspection Criterion	Pictures	Inspection method/tools	Defect category
No display /reaction	shows no picture/display in normal connected situation. ->Rejected		Naked eyes/ testers	MA
Missing segment	Shows missing lines in normal display		Naked eyes/ testers	MA
Image retention (sticking)	The previous picture stays in the next picture.Disappear time <10s, OK; time>10s, NG		Naked eyes/ testers	MA
Flicker	Not accepted		Naked eyes/ testers	MA
Display abnormal	Not accepted		Naked eyes/ testers	MA
Display dim/bright	Refer to limited sample	/	Naked eyes/ limited sample	MA
Contrast	Refer to limited sample	/	Naked eyes/ limited sample	MA
White dot	Refer to dot criterion	/	Naked eyes	MI
White speckle	Refer to limited sample	/	Naked eyes/ limited sample	MI
Yellow speckle	Refer to limited sample	/	Naked eyes/ limited sample	MI

12.6.3.2 LCD pixel dot defect(defect category: MI)

Item	Inspection criterion			
Size	S <5''	5≤S<10''	10≤S<15''	>15''
Color pixel dot defect(RGB dot)	1	2	2	3
2 connected bright dot	0	0	1	1
3 connected bright dot or more	0	0	0	0
Bright dot quantity	1	2	3	4
Random dark dot quantity	2	3	4	5
2 connected dark dot	1	1	2	2
3 connected dark dot or more	0	0	0	0

Item	Inspection criterion			
Dark dot quantity	3	4	5	6
Multi-bright dot	ND 5 % hidden, OK			
Remark: 2 bright dots distance DS≥15mm 2 dark dots distance DS≥5mm				
1) Bright dot: Power on TFT and RGB dot in black display				
2) Dark dot: Power on TFT and gray or black dot in RGB display				
3) Multi-bright dot: Power on TFT and fluorescent tiny dot in black display(only visible in black display)				

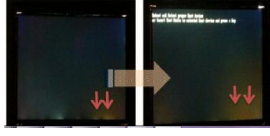
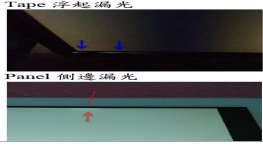
12.6.3.3 Backlight components

No.	Item	Description	Accepted criterion	MAJ.	MIN.
12.6.3.3.1	No backlight wrong Color	/	Rejected	√	
12.6.3.3.2	Color deviation	When powered on, the LCD color differs from its sample and found that the color not conforming to the drawing after testing.	Refer to sample and drawing.		√
12.6.3.3.3	Brightness deviation	When powered on, the LCD brightness differs from its sample and is found after testing not conforming to the drawing; or if it conforms to the drawing but the brightness over ±40% than its typical value.	Refer to sample and drawing.		√
12.6.3.3.4	Uneven brightness	Uneven on the same LCD and out of the specification of the drawing. The no specification evenness= (the max value-the min value)/ mean value< 70%.	Refer to sample and drawing.		√
12.6.3.3.5	Spot/line /scratch	When power on, it has dirty spot, scratches and so on spot and line defects.	Refer to 6.2.1		√

12.6.3.4 Metal frame (Metal Bezel)

No.	Item	Description	Accepted criterion	MAJ.	MIN.
12.6.3.4.1	Material & surface treatment	Metal frame/surface treatment do not conform to the specifications.	Rejected	√	
12.6.3.4.2	Tab twist Unconformity/ Tab not twisted	Wrong twist method or direction and twist tabs are not twisted as required.	Rejected	√	
12.6.3.4.3	Bezel paint loss	Scratch/paint loss/Bezel surface concave-convex dot/dent	1.Front surface: Paint peel off and scratch to the bottom Dot:D≤0.5mm, exceeds 3; Line:L≤3.0mm,W≤0.05mm exceeds 2;	√	
12.6.3.4.4	Bezel scratch			√	
12.6.3.4.5	Painting peel off, discoloration,dent, and scratch		2.Front dent, air bubble and side with paint peeling off scratch to the bottom Dot: D≤1.0mm, exceeds 3; Line:L≤3.0mm,W≤0.05mm, exceeds 2;	√	
12.6.3.4.6	Burr	Burr(s) on metal bezel is so long as to get into viewing area.	Rejected	√	

12.6.3.5 Others

No.	Item	Description	Accepted criterion	MAJ.	MIN.
12.6.3.5.1	Assembly foreign material	Dot/linear stain after assembly backlight and diffuse film TP assembly foggy stain	Invisible when power on->OK Refer to 6.2.1 dot/line spec		√
12.6.3.5.2	Product mark	Missing, unclear, incorrect, or misplaced part	Rejected		√
12.6.3.5.3	Newton's rings	Area<1/6 screen area quantity≤1	Accepted		√
12.6.3.5.4	Mura	1.In black display ND 5% invisible ->OK; visible->NG 2.Naked eyes inspection RGB display invisible Black display, area<1/4 screen area	Refer to limited sample 		√
12.6.3.5.5	Light leak	1.LCD edge (near backlight) shadow by LCD lamps irregular illuminate 2.Judge in black/white/gray display (slight leaky is yellowish,greenish, blueish ->NG); 	Refer to limited sample		√
12.6.3.5.6	Polarizer	1.Polarizer slant.Cover VA and not over LCD edge 2.No unmovable stain or finger print in polarizer VA 3.Bubble/warped but not enter VA	Accepted		√

12.6.4 General Appearance

12.6.4.1 Common function inspection equipment :micro calliper 、 vernier caliper 、 pencil hardness tester 、 spectrophotometer 、 drop ball test.

No.	Items	Spec
1	Dimension	According to drawing
2	Curl	≤0.3% -> OK, "S" curl ->NG
3	Surface hardness	According to drawing
4	VA TT (550nm)	According to drawing
5	IR TT-- (550nm & 850nm)	According to drawing
6	Intensity (drop ball test)	According to drawing

Remark: the criterion is common for all product and if some components are not included,just ignore it.

12.7. Others

Items not specified in this document or released on compromise should be inspected with reference to mutual agreement and limit samples.

13. HANDLING PRECAUTIONS

13.1 Mounting method

The LCD module consists of two thin glass plates with polarizers which easily be damaged. And since the module is so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

13.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent [recommended below] and wipe lightly :

- .Isopropyl alcohol
- .Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent :

- .Water
- .Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns

Do not use the following solvent on the pad or prevent it from being contaminated :

- .Soldering flux
- .Chlorine (Cl) , Sulfur (S)

If goods were sent without being silicon coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happens by miss-handling or using some materials such as Chlorine (Cl), Sulfur (S) from customer, Responsibility is on customer.

13.3 Caution against static charge

The LCD module uses C-MOS LSI drivers, so we recommend that you :

Connect any unused input terminal to Vdd or Vss, do not input any signals before power is turned on, and ground your body, work/assembly areas, assembly equipment to protect against static electricity.

13.4 Packing

Module employs LCD elements and must be treated as such.

- .Avoid intense shock and falls from a height.
- .To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity.

13.5 Caution for operation

- .It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage than the limit causes the shorter LCD life.
- .An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- .Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
- .If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- .A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.
- .Usage under the maximum operating temperature, 50%Rh or less is required.
- .When fixed patterns are displayed for a long time, remnant image is likely to occur.

13.6 Storage

In the case of storing for a long period of time for instance, for years for the purpose of replacement use, the following ways are recommended.

- .Storing in an ambient temperature 10°C to 30°C, and in a relative humidity of 45% to 75%. Don't expose to sunlight or fluorescent light.
- .Storing in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it . And with no desiccant.
- .Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- .Storing with no touch on polarizer surface by anything else.

It is recommended to store them as they have been contained in the inner container at the time of delivery from us.

13.7 Safety

- .It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- .When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water.

14. PRECAUTION FOR USE

14.1 A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

14.2 On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- .When a question is arisen in this specification.
- .When a new problem is arisen which is not specified in this specifications.
- .When an inspection specifications change or operating condition change in customer is reported to FEMA, and some problem is arisen in this specification due to the change.
- .When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

15. PACKING SPECIFICATION

Please consult our technical department for detail information.